

Manual

HIMax®

X-DI 32 51

Digital Input Module



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All the current manuals can be obtained upon request by sending an e-mail to: documentation@hima.com.

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X-DI 32 51 1 Introduction

1 Introduction

This manual describes the technical characteristics of the module and its use. It provides information on how to install, start up and configure the module in SILworX.

1.1 Structure and Use of This Manual

The content of this manual is part of the hardware description of the HIMax programmable electronic system.

This manual contains the following main chapters:

- Introduction
- Safety
- Product description
- Start-up
- Operation
- Maintenance
- Decommissioning
- Transport
- Disposal

Additionally, the following documents must be taken into account:

Document	Content	Document no.
HIMax system manual	Hardware description of the HIMax system	HI 801 001 E
HIMax safety manual	Safety functions of the HIMax system	HI 801 003 E
HIMax maintenance manual	Description of significant operational and maintenance actions.	HI 801 171 E
Communication manual	Description of safeethernet communication and of the available protocols.	HI 801 101 E
Automation security manual	Description of automation security aspects related to the HIMA systems.	HI 801 373 E
SILworX first steps manual	Introduction to SILworX	HI 801 103 E
SILworX online help (OLH)	Instructions on how to use SILworX	

Table 1: Additional Applicable Manuals

The current manuals can be obtained upon request by sending an e-mail to: documentation@hima.com. Registered customers can download the product documentation from the HIMA Extranet.

1.2 Target Audience

This document is aimed at the planners, design engineers, programmers and the persons authorized to start up, operate and maintain the automation systems. Specialized knowledge of safety-related automation systems is required.

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1 Introduction X-DI 32 51

1.3 Writing Conventions

To ensure improved readability and comprehensibility, the following writing conventions are used in this document:

Bold To highlight important parts.

Names of buttons, menu functions and tabs that can be clicked and used

in the programming tool.

Italics Parameters and system variables, references.

Courier Literal user inputs.

RUN Operating states are designated by capitals.

Chapter 1.2.3 Cross-references are hyperlinks even if they are not specially marked.

In the electronic document (PDF): When the mouse pointer hovers over a hyperlink, it changes its shape. Click the hyperlink to jump to the

corresponding position.

Safety notices and operating tips are specially marked.

1.3.1 Safety Notices

Safety notices must be strictly observed to ensure the lowest possible risk.

The safety notices are represented as described below.

- Signal word: warning, caution, notice.
- Type and source of risk.
- Consequences arising from non-observance.
- Risk prevention.

The signal words have the following meanings:

- Warning indicates hazardous situations which, if not avoided, could result in death or serious injury.
- Caution indicates hazardous situation which, if not avoided, could result in minor or moderate injury.
- Notice indicates a hazardous situation which, if not avoided, could result in property damage.

SIGNAL WORD



Type and source of risk!

Consequences arising from non-observance.

Risk prevention.

NOTICE



Type and source of damage! Damage prevention.

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X-DI 32 51 1 Introduction

1.3.2 Operating Tips Additional information is structured as presented in the following example: The text giving additional information is located here. Useful tips and tricks appear as follows:

TIP

The tip text is located here.

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2 Safety X-DI 32 51

2 Safety

All safety information, notes and instructions specified in this document must be strictly observed. The product may only be used if all guidelines and safety instructions are adhered to.

The product is operated with SELV or PELV. No imminent risk results from the product itself. Use in the Ex zone is only permitted if additional measures are taken.

2.1 Intended Use

HIMax components are designed for assembling safety-related controller systems.

When using the components in the HIMax system, comply with the following general requirements.

2.1.1 Environmental Requirements

All the environmental requirements specified in this manual must be observed when operating the HIMax system. The environmental requirements are listed in the product data.

2.1.2 ESD Protective Measures

Only personnel with knowledge of ESD protective measures may modify or extend the system or replace components.

NOTICE



Damage to the HIMax system due to electrostatic discharge!

- When performing the work, make sure that the workspace is free of static, and wear a grounding strap.
- If not used, ensure that the components are protected from electrostatic discharge, e.g., by storing them in their packaging.

2.2 Residual Risk

No imminent risk results from a HIMA system itself.

Residual risk may result from:

- Faults related to engineering.
- Faults in the user program.
- Faults related to the wiring.

2.3 Safety Precautions

Observe all local safety requirements and use the protective equipment required on site.

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3 Product Description

The X-DI 32 51 is a digital NonSIL input module and it is intended for use in the programmable electronic system (PES) HIMax.

The module is used to evaluate up to 32 digital input signals.

The module can be inserted into any of the base plate slots with the exception of the slots reserved for system bus modules. Refer to the system manual (HI 801 001 E) for details.

The module can be operated with safety-related modules and other NonSIL modules within one base plate. Safety-related and NonSIL modules may not be wired redundantly.

The module is interference-free. In particular with respect to EMC, electrical safety, communication to the X-SB and X-CPU modules, and the user program.

Module and connector boards are mechanically coded, see Chapter 3.6.1. Coding prevents installation of unsuitable I/O modules.

Refer to the HIMax safety manual (HI 801 003 E) for further information on the standards used to test and certify the modules and the HIMax system.

The certificates and the EU type test certificate are available on the HIMA website.

3.1 Safety Function

The module evaluates the digital input signals and provides them to the user program.

The module does not perform any safety-related functions.

The parameters and status for this module must not be used for safety functions.

3.1.1 Response in the Event of a Fault

If a fault occurs, the assigned input variables transmit the initial value to the user program.

The initial values must be set to 0 to ensure that the input variables transmit the value 0 to the user program if a fault occurs.

The module activates the Error LED on the front plate.

3.2 Scope of Delivery

To operate, the module must be installed on a matching connector board. If a field termination assembly (FTA) is used, a system cable is required to connect the connector board to the FTA. Connector boards, system cables and FTAs are not included within the scope of delivery.

The connector boards are described in Chapter 3.7, the system cables are described in Chapter 3.8. The FTAs are described in separate manuals.

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3.3 Type Label

The type label specifies the following important details:

- Product name
- Mark of conformity
- Bar code (2D or 1D code)
- Part number (Part-No.)
- Hardware revision index (HW-Rev.)
- Operating system revision index (OS-Rev.)
- Supply voltage (Power)
- Ex specifications (if applicable)
- Production year (Prod-Year:)



Figure 1: Sample Type Label

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3.4 Structure

The module has 32 safety-related digital inputs (24) for digital signals, mechanical contact switching devices (mechanical contacts) and proximity switches (2-wire or 3-wire). For detecting a high level on the digital input, the voltage and current thresholds must be exceeded (see Table 7).

The 8 short-circuit-proof supplies feed 4 supply outputs each (S1+ to S8+). One supply output is assigned to each digital input.

The processor system within the I/O module controls and monitors the I/O level. The data and states of the I/O module are provided to the processor modules via the redundant system bus. The system bus has a redundant structure for reasons of availability. Redundancy is only ensured if both system bus modules are inserted in the base plates and configured in SILworX.

The module is equipped with LEDs to indicate the status of the digital inputs, see Chapter 3.4.2.

3.4.1 Block Diagram

The following block diagram illustrates the structure of the module:

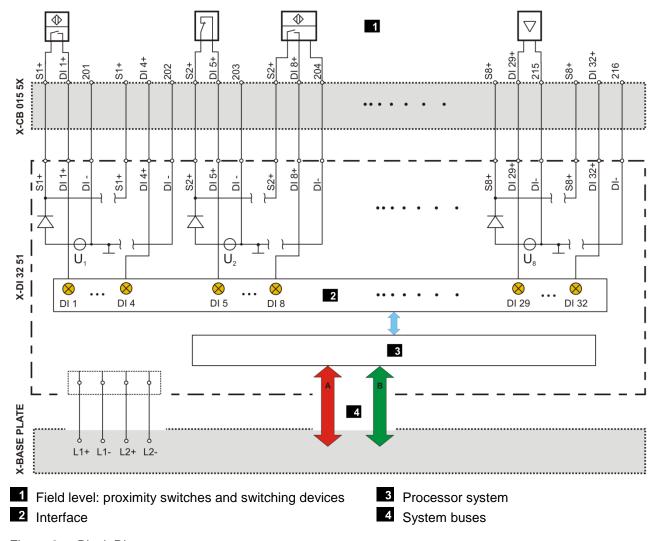


Figure 2: Block Diagram

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3.4.2 Indicators

The following figure shows the front view of the module with the LEDs:

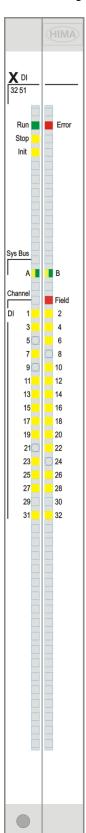


Figure 3: Indicators

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The LEDs indicate the operating state of the module. All LEDs should be considered together. The LEDs on the module are divided into the following groups:

- Module status indicators (Run, Error, Stop, Init)
- System bus indicators (A, B)
- I/O indicators (DI 1...32, Field)

After connecting the supply voltage, an LED test is performed and all the LEDs are lit for at least 2 s. The color of two-color LEDs changes once during the test.

Definition of blinking frequencies

The following table defines the blinking frequencies:

Definition	Blinking frequencies
Blinking1	Long (600 ms) on, long (600 ms) off.
Blinking2	Short (200 ms) on, short (200 ms) off, short (200 ms) on, long (600 ms) off.
Blinking-x	Ethernet communication: Blinking synchronously with data transmission.

Table 2: Blinking Frequencies of the LEDs

Some LEDs can report warnings (On) and faults or errors (Blinking1), see the following tables. The indication of errors or faults has priority over the indication of warnings. Warnings cannot be reported if errors or faults are being signaled.

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3.4.3 Module Status Indicators

These LEDs are located on the upper part of the front plate.

LED	Color	Status	Description
Run	Green	On	Module in the RUN state, normal operation.
		Blinking1	Module state STOP / LOADING OS
		Off	Module not in the RUN state, observe the other status LEDs.
Error	Red	On	System warning, for example: No license for additional functions (e.g., communication protocols), test mode. Temperature warning
		Blinking1	System error, for example: Internal module faults detected by self-tests, e.g., hardware or voltage supply faults. Fault while loading the operating system.
		Off	No faults detected
Stop	Yellow	On	Module state STOP / VALID CONFIGURATION
		Blinking1	The module is in one of the following states: STOP / INVALID CONFIGURATION STOP / LOADING OS
		Off	Module not in the STOP state, observe the other status LEDs.
Init	Yellow Yellow	On	Module state: INIT
		Blinking1	The module is in one of the following states: LOCKED STOP / LOADING OS
		Off	Module is in none of the states described, observe the other status LEDs.

Table 3: Module Status Indicators

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3.4.4 System Bus Indicators

The system bus indicator LEDs are labeled Sys Bus.

LED	Color	Status	Description
А	Green	On	Physical and logical connection to the system bus module in slot 1.
		Blinking1	No physical connection to the system bus module in slot 1.
	Yellow	Blinking1	The physical connection to the system bus module in slot 1 has been established.
			No connection to a (redundant) processor module running in system operation.
B Gree	Green	On	Physical and logical connection to the system bus module in slot 2.
		Blinking1	No physical connection to the system bus module in slot 2.
	Yellow	Blinking1	The physical connection to the system bus module in slot 2 has been established.
			No connection to a (redundant) processor module running in system operation.
A+B	Off	Off	Neither physical nor logical connection to the system bus modules in slot 1 and slot 2.

Table 4: System Bus Indicators

3.4.5 I/O Indicators

The LEDs of the I/O indicators are labeled Channel.

LED	Color	Status	Description
DI 1DI 3	Yellow	On	High level present.
2		Blinking2	Channel fault.
		Off	Low level present.
Field	Red	Blinking2	Without function.
		Off	

Table 5: I/O Indicators

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3.5 Product Data

General information	
Supply voltage	24 VDC, -15+20 %, r _p ≤ 5 %
	SELV, PELV
Current consumption	250 mA at 24 VDC (without channels and supplies)
	Max. 1.5 A (in case of short-circuit of the supplies)
Module cycle time	2 ms
Protection class	Protection class III in accordance with IEC/EN 61131-2
Ambient temperature	0+60 °C
Transport and storage temperature	-40+70 °C
Humidity	Max. 95 % relative humidity, non-condensing
Pollution	Pollution degree II in accordance with IEC/EN 60664-1
Installation height	< 2000 m
Degree of protection	IP20
Dimensions (H x W x D) in mm	310 x 29.2 x 230
Weight	Approx. 1 kg

Table 6: Product Data

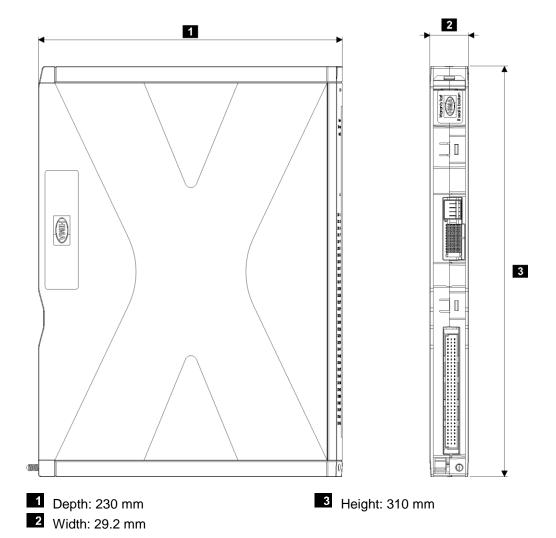


Figure 4: Views

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Digital inputs	
Number of inputs (number of channels)	32 unipolar with reference pole DI- / L-,
	Not galvanically separated from one another
Type of input	Current sinking logic, 24 VDC, type 3 in accordance with IEC 61131-2
Rated input voltage	024 V
Input voltage operating range	-330 V (current limited to approx. 2.5 mA)
Voltage range low level	-35 V
Voltage range high level	1130 V
Switching point	Typ. $9.3 \text{ V} \pm 0.4 \text{ V} (2.1 \text{ mA} \pm 0.15 \text{ mA})$

Table 7: Specifications for Digital Inputs

Supply		
Number of supplies	8, with 4 outputs each	
Output voltage for supply	Supply voltage - 2.5 VDC	
Output current for supply	100 mA for each group	
	Short-circuit-proof	
Assignment of Supply Outputs		
The supply output assigned to ea	ch input must be used for power supply!	
Supply S1+	DI1+DI4+	
Supply S2+	DI5+DI8+	
Supply S3+	DI9+DI12+	
Supply S4+	DI13+DI16+	
Supply S5+	DI17+DI20+	
Supply S6+	DI21+DI24+	
Supply S7+	DI25+DI28+	
Supply S8+	DI29+DI32+	

Table 8: Supply Specifications

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3.6 Connector Boards

A connector board connects the module to the field level. Module and connector board together form a functional unit. Insert the connector board into the appropriate slot prior to mounting the module.

The following connector boards are available for the module:

Connector board	Description
X-CB 015 51	Mono connector board with screw terminals.
X-CB 015 52	Redundant connector board with screw terminals
X-CB 015 53	Mono connector board with cable plug.
X-CB 015 54	Redundant connector board with cable plug

Table 9: Available Connector Boards

3.6.1 Mechanical Coding of Connector Boards

I/O modules and connector boards are mechanically coded starting from hardware revision index (HW-Rev.) 00. Coding avoids installation of improper I/O modules thus preventing negative effects on redundant modules and the field level.

Apart from that, improper equipment has no effect on the HIMax system since only I/O modules properly configured in SILworX can enter the RUN state.

I/O modules and the corresponding connector boards have a mechanical coding in the form of wedges. The coding wedges in the female connector of the connector board match with the male connector recesses of the I/O module plug, see Figure 5.

Coded I/O modules can only be plugged in to the corresponding connector boards.

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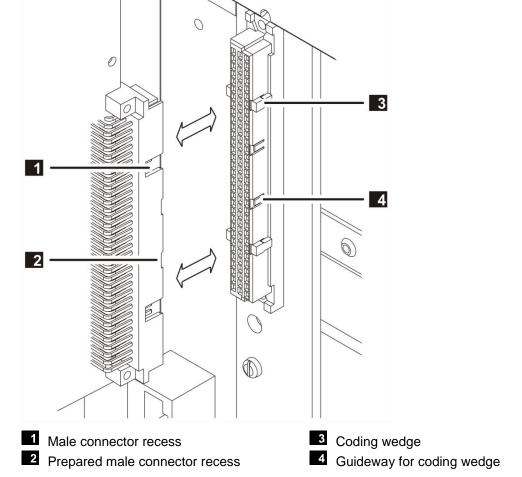


Figure 5: Coding Example

Coded I/O modules can be plugged in to uncoded connector boards. Uncoded I/O modules cannot be plugged in to coded connector boards.

3.6.2 Coding of X-CB 015 5x Connector Boards

The following table specifies the position of the coding wedges on the I/O module plug:

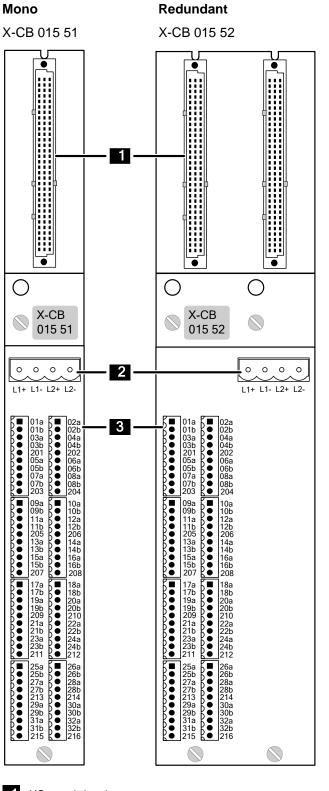
a7	a13	a20	a26	c7	c13	c20	c26
X		X	Х			Х	

Table 10: Position of Coding Wedges

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3 Product Description X-DI 32 51

3.6.3 Connector Boards with Screw Terminals



- 1/O module plug
- External supply connection, not required for X-DI 32 51

Figure 6: Connector Boards with Screw Terminals

Connection to the field level (screw terminals)

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3.6.4 Terminal Assignment for Connector Boards with Screw Terminals

Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	01a	S1+	1	02a	S1+
2	01b	DI1+	2	02b	DI2+
3	03a	S1+	3	04a	S1+
4	03b	DI3+	4	04b	DI4+
5	201	DI-	5	202	DI-
6	05a	S2+	6	06a	S2+
7	05b	DI5+	7	06b	DI6+
8	07a	S2+	8	08a	S2+
9	07b	DI7+	9	08b	DI8+
10	203	DI-	10	204	DI-
Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	09a	S3+	1	10a	S3+
2	09b	DI9+	2	10b	DI10+
3	11a	S3+	3	12a	S3+
4	11b	DI11+	4	12b	DI12+
5	205	DI-	5	206	DI-
6	13a	S4+	6	14a	S4+
7	13b	DI13+	7	14b	DI14+
8	15a	S4+	8	16a	S4+
9	15b	DI15+	9	16b	DI16+
					.
10	207	DI-	10	208	DI-
Pin no.	207 Designation	DI- Signal	10 Pin no.	208 Designation	Signal
			Pin no.		
Pin no.	Designation	Signal	Pin no.	Designation	Signal
Pin no.	Designation 17a	Signal S5+	Pin no.	Designation 18a	Signal S5+
Pin no.	Designation 17a 17b	Signal S5+ DI17+	Pin no. 1 2 3 4	Designation 18a 18b	Signal S5+ DI18+
Pin no. 1 2 3	Designation 17a 17b 19a	Signal S5+ DI17+ S5+	Pin no. 1 2 3	Designation 18a 18b 20a	Signal S5+ DI18+ S5+
Pin no. 1 2 3 4 5	Designation 17a 17b 19a 19b	Signal S5+ DI17+ S5+ DI19+	Pin no. 1 2 3 4 5	Designation 18a 18b 20a 20b	Signal S5+ DI18+ S5+ DI20+
Pin no. 1 2 3 4 5	Designation 17a 17b 19a 19b 209	Signal S5+ DI17+ S5+ DI19+ DI-	Pin no. 1 2 3 4 5	Designation 18a 18b 20a 20b 210	Signal S5+ DI18+ S5+ DI20+ DI-
Pin no. 1 2 3 4 5	Designation 17a 17b 19a 19b 209 21a	Signal S5+ DI17+ S5+ DI19+ DI- S6+	Pin no. 1 2 3 4 5	Designation 18a 18b 20a 20b 210 22a	Signal S5+ DI18+ S5+ DI20+ DI- S6+
Pin no. 1 2 3 4 5 6 7	Designation 17a 17b 19a 19b 209 21a 21b	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+	Pin no. 1 2 3 4 5 6 7	Designation 18a 18b 20a 20b 210 22a 22b	Signal S5+ DI18+ S5+ DI20+ DI- S6+ DI22+
Pin no. 1 2 3 4 5 6 7	Designation 17a 17b 19a 19b 209 21a 21b 23a	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+	Pin no. 1 2 3 4 5 6 7	Designation 18a 18b 20a 20b 210 22a 22b 24a	Signal S5+ DI18+ S5+ DI20+ DI- S6+ DI22+ S6+
Pin no. 1 2 3 4 5 6 7 8 9	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+	Pin no. 1 2 3 4 5 6 7 8	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b	Signal S5+ DI18+ S5+ DI20+ DI- S6+ DI22+ S6+ DI24+
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI-	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212	Signal S5+ DI18+ S5+ DI20+ DI- S6+ DI22+ S6+ DI24+ DI-
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211 Designation	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI- Signal	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212 Designation	Signal S5+ DI18+ S5+ DI20+ DI- S6+ DI22+ S6+ DI24+ DI- Signal
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211 Designation 25a	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI- Signal S7+	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212 Designation 26a	Signal S5+ D118+ S5+ D120+ D1- S6+ D122+ S6+ D124+ D1- Signal S7+
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211 Designation 25a 25b	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI- Signal S7+ DI25+ S7+ DI27+	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212 Designation 26a 26b 28a 28b	Signal S5+ D118+ S5+ D120+ D1- S6+ D122+ S6+ D124+ D1- Signal S7+ D126+
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211 Designation 25a 25b 27a	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI- Signal S7+ DI25+ S7+	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212 Designation 26a 26b 28a	Signal S5+ DI18+ S5+ DI20+ DI- S6+ DI22+ S6+ DI24+ DI- Signal S7+ DI26+ S7+
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5 6	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211 Designation 25a 25b 27a 27b	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI- Signal S7+ DI25+ S7+ DI27+	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5 6	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212 Designation 26a 26b 28a 28b 214 30a	Signal S5+ D118+ S5+ D120+ D1- S6+ D122+ S6+ D124+ D1- Signal S7+ D126+ S7+ D128+
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211 Designation 25a 25b 27a 27b 213	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI- Signal S7+ DI25+ S7+ DI27+ DI-	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212 Designation 26a 26b 28a 28b 214	Signal S5+ DI18+ S5+ DI20+ DI- S6+ DI22+ S6+ DI24+ DI- Signal S7+ DI26+ S7+ DI28+ DI-
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5 6 7 8 8	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211 Designation 25a 25b 27a 27b 213 29a	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI- Signal S7+ DI25+ S7+ DI27+ DI- S8+	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5 6 7 8 8	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212 Designation 26a 26b 28a 28b 214 30a	Signal S5+ DI18+ S5+ DI20+ DI- S6+ DI22+ S6+ DI24+ DI- Signal S7+ DI26+ S7+ DI28+ DI- S8+
Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5 6 7	Designation 17a 17b 19a 19b 209 21a 21b 23a 23b 211 Designation 25a 25b 27a 27b 213 29a 29b	Signal S5+ DI17+ S5+ DI19+ DI- S6+ DI21+ S6+ DI23+ DI- Signal S7+ DI25+ S7+ DI27+ DI- S8+ DI29+	Pin no. 1 2 3 4 5 6 7 8 9 10 Pin no. 1 2 3 4 5 6 7	Designation 18a 18b 20a 20b 210 22a 22b 24a 24b 212 Designation 26a 26b 28a 28b 214 30a 30b	Signal S5+ D118+ S5+ D120+ D1- S6+ D122+ S6+ D124+ D1- Signal S7+ D126+ S7+ D128+ D1- S8+ D1- S8+ D1- S8+ D1-

Table 11: Terminal Assignment for Connector Boards with Screw Terminals

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Cable plugs attached to the connector board pin headers are used to connect to the field level and to external power supplies.

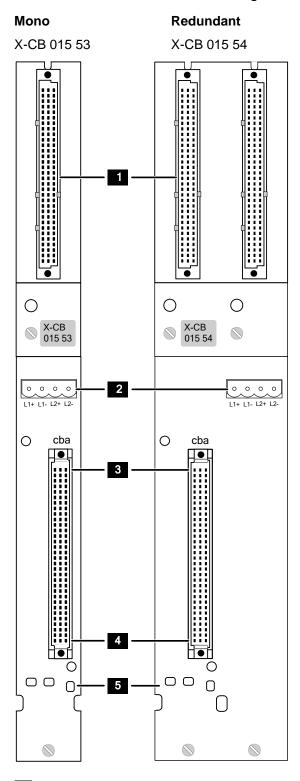
The cable plugs feature the following characteristics:

Connection to the field level			
Cable plugs	8 pieces, with 10 poles		
Wire cross-section	0.21.5 mm ² (single-wire) 0.21.5 mm ² (finely stranded) 0.21.5 mm ² (with wire end ferrule)		
Stripping length	6 mm		
Screwdriver	Slotted 0.4 x 2.5 mm		
Tightening torque	0.20.25 Nm		

Table 12: Cable Plug Characteristics

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3.6.5 Connector Boards with Cable Plug



- 1 I/O module plug
- External supply connection, not required for X-DI 32 51
- Connection to the field level (cable plug in row 1)

Figure 7: Connector Boards with Cable Plug

- 4 Connection to the field level (cable plug in row 32)
- 5 Coding of cable plugs

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3 Product Description X-DI 32 51

3.6.6 Pin Assignment for Connector Boards with Cable Plug

HIMA provides ready-made system cables for use with these connector boards, see Chapter 3.7. The cable plug and the connector boards are coded.

Connector pin assignment!

The following table describes the connector pin assignment of the system cable plug.

The wire color coding complies with IEC 60304. The color abbreviations used are in accordance with IEC 60757.

The following table applies to system cables X-CA 001:

Row	С		b	b		а	
ROW	Signal	Color	Signal	Color	Signal	Color	
1			DI32+	YEBU		RD 1)	
2			DI31+	GNBU	Internal	BU 1)	
3			DI30+	YEPK	use ²⁾	PK 1)	
4			DI29+	PKGN		GY 1)	
5			DI28+	YEGY			
6			DI27+	GYGN			
7			DI26+	BNBK			
8			DI25+	WHBK			
9			DI24+	BNRD			
10			DI23+	WHRD			
11			DI22+	BNBU			
12			DI21+	WHBU			
13			DI20+	PKBN			
14			DI19+	WHPK			
15			DI18+	GYBN			
16			DI17+	WHGY			
17			DI16+	YEBN	DI-	YE 1)	
18			DI15+	WHYE	DI-	GN ¹⁾	
19			DI14+	BNGN	DI-	BN ¹⁾	
20			DI13+	WHGN	DI-	WH 1)	
21			DI12+	RDBU	DI-	RDBK	
22			DI11+	GYPK	DI-	BUBK	
23			DI10+	VT	DI-	PKBK	
24			DI9+	BK	DI-	GYBK	
25			DI8+	RD	S8+	PKRD	
26			DI7+	BU	S7+	GYRD	
27			DI6+	PK	S6+	PKBU	
28			DI5+	GY	S5+	GYBU	
29			DI4+	YE	S4+	YEBK	
30			DI3+	GN	S3+	GNBK	
31			DI2+	BN	S2+	YERD	
32			DI1+	WH	S1+	GNRD	

¹⁾ For repeated wire color coding: Additional orange ring.

Table 13: Pin Assignment for the System Cable Plug

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²⁾ The wires must be isolated individually! No other use is permitted!

The following table applies to system cables X-CA 015:

Row	c b			а		
ROW	Signal	Color	Signal	Color	Signal	Color
1			DI32+	WHPK 1)		
2			DI31+	WHGY 1)		
3			DI30+	WHYE 1)		
4			DI29+	WHGN 1)		
5			DI28+	GYPK 1)		
6			DI27+	BK 1)		
7			DI26+	BU 1)		
8			DI25+	GY 1)		
9			DI24+	GN 1)		
10			DI23+	WH 1)		
11			DI22+	BUBK		
12			DI21+	GYBK		
13			DI20+	GYRD		
14			DI19+	GYBU		
15			DI18+	GNBK		
16			DI17+	GNRD		
17			DI16+	GNBU		
18			DI15+	PKGN		
19			DI14+	GYGN		
20			DI13+	WHBK		
21			DI12+	WHRD		
22			DI11+	WHBU		
23			DI10+	WHPK		
24			DI9+	WHGY		
25			DI8+	WHYE	S8+ (a25)	
26			DI7+	WHGN	S7+ (a26)	
27			DI6+	GYPK	S6+ (a27)	
28			DI5+	BK	S5+ (a28)	See
29			DI4+	BU	S4+ (a29)	Table 15
30			DI3+	GY	S3+ (a30)	
31			DI2+	GN	S2+ (a31)	1
32			DI1+	WH	S1+ (a32)	1
1) For repe	eated wire co	lor coding: Ad	ditional orange	ring.		

Table 14: Pin Assignment for the Cable Plugs of System Cable X-CA 015

In the cable plug, the S+ signals are combined into groups of four wires, see Table 15.

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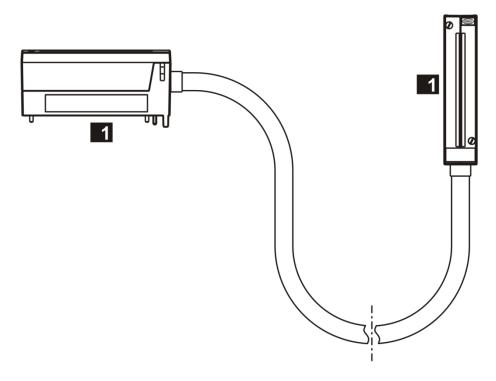
Row	Signal	Color
a25 (S8+)	S8+	PKBN ¹⁾
	S8+	GYBN 1)
	S8+	YEBN 1)
	S8+	BNGN 1)
a26 (S7+)	S7+	RDBU ¹⁾
	S7+	VT 1)
	S7+	RD ¹⁾
	S7+	PK ¹⁾
a27 (S6+)	S6+	YE 1)
	S6+	BN ¹⁾
	S6+	RDBK
	S6+	PKBK
a28 (S5+)	S5+	PKRD
	S5+	PKBU
	S5+	YEBK
	S5+	YERD
a29 (S4+)	S4+	YEBU
	S4+	YEPK
	S4+	YEGY
	S4+	BNBK
a30 (S3+)	S3+	BNRD
	S3+	BNBU
	S3+	PKBN
	S3+	GYBN
a31 (S2+)	S2+	YEBN
	S2+	BNGN
	S2+	RDBU
	S2+	VT
a32 (S1+)	S1+	RD
	S1+	PK
	S1+	YE
	S1+	BN
1) For repeated wire color co	ding: Additional orange ring.	

Table 15: Each S+ Used with Four Wires

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3.7 System Cables

The system cables connect the connector boards to the field termination assemblies. Depending on the type of connector board, several types of system cables are available. System cable X-CA 015 with reduced number of wires and open wire ends is available for applications with passive 2-wire proximity switches and passive electromechanical switching devices.



1 Identical cable plugs

Figure 8: System Cable with Cable Plug on Both Sides

3.7.1 System Cable X-CA 001

System cable X-CA 001 is used to connect the X-CB 015 03/04 connector board to one field termination assembly.

General information	
Cable	LIYY-TP 34 x 2 x 0.25 mm ²
Wire	Finely stranded
Average outer diameter (d)	Approx. 15.2 mm
	Max. 20 mm for all types of system cables
Minimum bending radius	
Fixed installation	5 x d
Flexible application	10 x d
Burning behavior	Flame retardant and self-extinguishing in accordance with IEC 60332-1-2, IEC 60332-2-2
Length	830 m
Color coding	Based on DIN 47100, see Table 13.

Table 16: Cable Data X-CA 001

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The system cable is available in the following standard lengths:

System cables	Description	Length	Weight
X-CA 001 01 8	Coded cable plugs on both	8 m	3.75 kg
X-CA 001 01 15	sides.	15 m	7 kg
X-CA 001 01 30		30 m	14 kg

Table 17: Available Standard System Cables X-CA 001

3.7.2 System Cable X-CA 015

System cable X-CA 015 can only be used for connection of passive 2-wire proximity switches and passive electromechanical switching devices. System cable X-CA 015 is implemented with a reduced number of wires and open wire ends. The open wire ends must be connected to terminals.

The system cable is available as standard type (X-CA 015 02) and as halogen-free, UL/CSA certified type (X-CA 015 04) in the following standard lengths:

System cables	Description	Length	Weight
X-CA 015 02 5	Cable plug coded on one side, with	5 m	1.75 kg
X-CA 015 02 8	open wire ends.	8 m	2.75 kg
X-CA 015 02 15		15 m	5.25 kg
X-CA 015 02 30		30 m	10.5 kg
X-CA 015 04 5	Cable plug coded on one side, with	5 m	1.50 kg
X-CA 015 04 8	open wire ends, halogen-free.	8 m	2.75 kg
X-CA 015 04 15		15 m	4.50 kg
X-CA 015 04 30		30 m	9.0 kg

Table 18: Available Standard System Cables X-CA 015

X-CA 015 02	
Cable	LIYY-TP 32 x 2 x 0.25 mm ²
Wire	Finely stranded
Average outer diameter (d)	Approx. 16.3 mm, max. 20 mm for all types of system cables
Minimum bending radius	
Fixed installation	5 x d
Flexible application	10 x d
Burning behavior	Flame retardant and self-extinguishing in accordance with IEC 60332-1-2, IEC 60332-2-2
Length	530 m
Color coding	Based on DIN 47100, see Table 14.

Table 19: Cable Data X-CA 015 02

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X-CA 015 04	
Cable	LIHH-TP 32 x 2 x 0.25 mm ²
Wire	Finely stranded
Average outer diameter (d)	Approx. 15.0 mm max. 20 mm for all types of system cables
Minimum bending radius	
Fixed installation	5 x d
Flexible application	10 x d
Burning behavior	Flame retardant in accordance with IEC 60332-1-2, IEC 60332-2-2 IEC 61034-1/IEC 61034-2 (smoke density) UL c/us 758/1581 CSA FT2 UL c/us 20549/10493
Halogen-free	In accordance with IEC 60754-1
Length	530 m
Color coding	Based on DIN 47100, see Table 14

Table 20: Cable Data X-CA 015 04

3.7.3 Cable Plug Coding

The cable plugs are equipped with three coding pins. Therefore, cable plugs only match connector boards and FTAs encoded accordingly, see Figure 7.

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4 Start-Up X-DI 32 51

4 Start-Up

This chapter describes how to install, configure and connect the module. For further details, refer to the HIMax system manual (HI 801 001 E).

4.1 Mounting

Observe the following points when mounting the module:

- Only operate the module with the appropriate fan components. For further details, see the system manual (HI 801 001 E).
- Only operate the module with the suitable connector board. For further details, see Chapter 3.6.
- The module, including its connected components, must be installed to ensure compliance with the requirements for degree of protection IP20 or higher in accordance with EN 60529:1991 + A1:2000.

NOTICE



Damage due to incorrect wiring!

Failure to comply with these instructions can damage the electronic components. Observe the following points.

- Plugs and terminals connected to the field level.
 - Take the appropriate grounding measures when connecting the plugs and terminals to the field level.
 - An unshielded cable may be used for connecting the proximity switches and switching devices to the digital inputs.
 - If shielded cables are used, connect the shielding on both sides. On the module side, the shielding must be connected to the cable shield rail (use SK 20 shield connection terminal block or similar).
 - If finely stranded wires are used, HIMA recommends fastening ferrules to the wire ends.
 The terminals must be suitable for fastening the cross-sections of the cables in use.
- If the supply is used, utilize the voltage output used for the assigned input, see Table 8. HIMA recommends using the supply of the module.
 If an external current source is malfunctioning, the affected module's measuring input can be overloaded and damaged. If an external current source is used, the switching thresholds must be checked after a non-transient overload occurred at the measuring inputs.
- The inputs can be interconnected redundantly using the corresponding connector boards, see Chapters 3.6 and 4.4.

4.1.1 Wiring Unused Inputs

Inputs that are not being used may stay open and need not be terminated. To prevent short-circuits and sparks in the field, never connect a wire to a connector board if it is open on the field level.

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4.2 Mounting and Removing the Module

This chapter describes how to replace an existing module or mount a new one.

When removing the module, the connector board remains in the HIMax base plate. This saves additional wiring effort at the clamp terminals since all field terminals are connected via the connector board of the module.

4.2.1 Mounting a Connector Board

Tools and utilities:

- Screwdriver, cross PH 1 or slotted 0.8 x 4.0 mm.
- Matching connector board.

To install the connector board

- 1. Insert the connector board into the guiding rail with the groove facing upwards (see following drawing). Fit the groove into the guiding rail pin.
- 2. Place the connector board on the cable shield rail.
- Secure the captive screws to the base plate. First screw in the lower screws than the upper ones.

To remove the connector board

- 1. Release the captive screws from the base plate.
- 2. Carefully lift the lower section of the connector board from the cable shield rail.
- 3. Remove the connector board from the guiding rail.

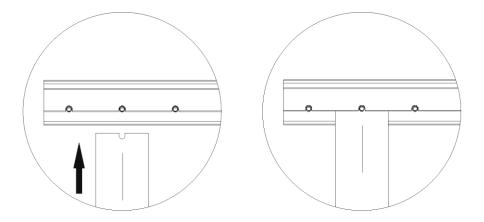


Figure 9: Example of how to Insert the Mono Connector Board

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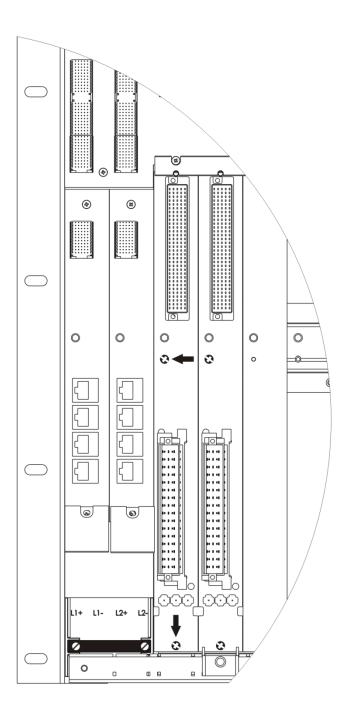


Figure 10: Example of how to Secure the Mono Connector Board with Captive Screws

These instructions also apply for redundant connector boards. The number of used slots varies in accordance with the connector board type. The number of captive screws depends on the connector board type.

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4.2.2 Mounting and Removing a Module

This chapter describes how to mount and remove the HIMax module. A module can be mounted and removed while the HIMax system is operating.

NOTICE



Damage to bus and power sockets due to module jamming!
Failure to comply with these instructions can damage the controller.

Always insert the module in the base plate carefully.

Tools and utilities:

- Screwdriver, slotted 0.8 x 4.0 mm.
- Screwdriver, slotted 1.2 x 8.0 mm.

To insert the modules

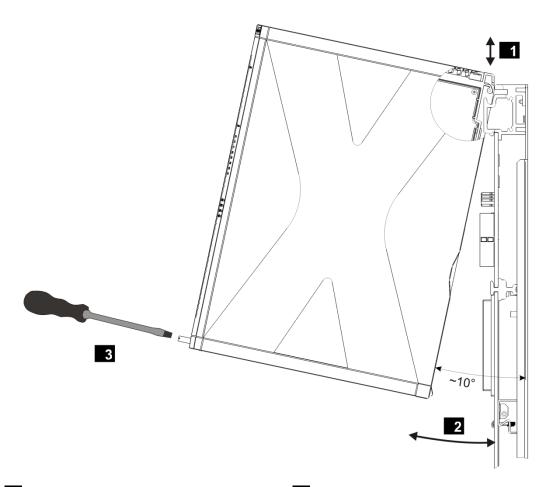
- 1. Open the cover plate on the fan rack:
 - ☑ Move the locks to the *open* position.
 - ☑ Lift the cover plate and insert it into the fan rack.
- Insert the top of the module into the hook-in rail, see
- 3. Swivel the lower edge of the module towards the base plate and apply light pressure to snap it into place, see 2.
- 4. Tighten the screws, see 3.
- 5. Pull the cover plate out of the fan rack and close it.
- 6. Lock the cover plate.

To remove the modules

- 1. Open the cover plate on the fan rack:
 - ☑ Move the locks to the *open* position.
 - ☑ Lift the cover plate and insert it into the fan rack.
- Release the screw, see 3.
- 3. Swivel the lower edge of the module away from the base plate. Lift and apply light pressure to remove the module from the hook-in rail, see 2 and 1.
- 4. Pull the cover plate out of the fan rack and close it.
- 5. Lock the cover plate.

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- Inserting and removing a module
- 2 Swiveling the module in and out
- 3 Securing and releasing a module

Figure 11: Mounting and Removing a Module

If the HIMax system is operating, do not open the cover plate of the fan rack for more than a few minutes (< 10 min) since this affects the forced cooling.

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4.3 Configuring the Module in SILworX

The module is configured in the Hardware Editor of the SILworX programming tool.

Observe the following points when configuring the module:

 To diagnose the module and channels, both the statuses and the measured value can be evaluated within the user program. For further details on the system parameters, refer to the following tables.

• If a redundancy group is created, its configuration is defined in the tabs. The tabs specific to the redundancy group differ from those of the individual modules, see the following tables.

To evaluate the system parameters in the user program, they must be assigned to global variables. Perform this step in the Hardware Editor using the module's detail view.

The following tables present the system parameters for the module in the same order as in the SILworX Hardware Editor.

TIP

A scientific calculator such as the Windows® calculator with the corresponding view can be used to convert hexadecimal values to bit strings.

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4 Start-Up X-DI 32 51

4.3.1 The **Module** Tab

The **Module** tab contains the following system parameters for the module:

System parameter	Data type	R/W	Description	
Name		W	Module name.	
Spare Module		W	Activated: It is not considered a fault if a module of the redundancy group is missing in the base plate. Deactivated: It is considered a fault if a module of the redundancy group is missing in the base plate. Default setting: Deactivated It is only displayed in the redundancy group tab!	
Noise Blanking		W	Allow noise blanking performed by the process module (Activated/Deactivated). Default setting: Activated The processor module delays its response to transient interference until the safety time. The user program retains its last valid process value. Refer to the system manual (HI 801 001 E) for further details on noise blanking.	
System parameter	Data type	R/W	Description	
The following statuses and parameters can be assigned global variables and used in the user program.				
Module OK	BOOL	R	TRUE: Mono operation: No module faults. Redundancy operation: At least one of the redundant modules has no module fault (OR logic). FALSE: Module fault. Channel fault on one channel (no external faults). The module is not plugged in. Observe the Module Status parameter!	
Module Status	DWORD	R	Status of the module.	
			0x00000001 M 0x00000002 Te 0x00000004 Te 0x00000008 In 0x00000010 Vo 0x00000020 Vo 0x00000040 In 0x80000000 No	Description Module fault. 1) Temperature threshold 1 exceeded. Temperature threshold 2 exceeded. The correct temperature value. Moltage on L1+ is defective. Moltage on L2+ is defective. The connection to the module. 1) affect the Module OK status and need at ley evaluated in the user program.
Timestamp [µs]	DWORD	R	Microsecond fraction of the timestamp.	
Timestamp [s]	DWORD	R	Point in time when the digital inputs were measured. Second fraction of the timestamp. Point in time when the digital inputs were measured.	

Table 21: The **Module** Tab in the Hardware Editor

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4.3.2 The **I/O Submodule DI 32_51** Tab

The **I/O Submodule DI32_51** tab contains the following system parameters:

System parameter	Data type	R/W	Description		
This parameter cannot be changed.					
Name		R	Tab name		
System parameter	Data type	R/W	Description		
The following statuses a	ind parameters	s can be a	ssigned global variables and used in the user program.		
Background Test Error	BOOL	R	TRUE: Background test is faulty. FALSE: Background test is not faulty.		
Diagnostic Request	DINT	W	To request a diagnostic value, the appropriate ID must be sent to the module using the parameter <i>Diagnostic Request</i> (for coding details, see Chapter 4.3.5).		
Diagnostic Response	DINT	R	As soon as <i>Diagnostic Response</i> returns the ID of <i>Diagnostic Request</i> (for coding details, see Chapter 4.3.5), <i>Diagnostic Status</i> contains the diagnostic value requested.		
Diagnostic Status	DWORD	R	Requested diagnostic value in accordance with <i>Diagnostic Response</i> . The IDs of <i>Diagnostic Request</i> and <i>Diagnostic Response</i> can be evaluated in the user program. <i>Diagnostic Status</i> only contains the requested diagnostic value when both <i>Diagnostic Request</i> and <i>Diagnostic Response</i> have the same ID.		
Restart on Error	BOOL	W	The Restart on Error parameter can be used to cause any I/O module that is shut down permanently due to errors or faults to once again enter the RUN state. To do so, set the Restart on Error parameter from FALSE to TRUE. The I/O module performs a complete self-test and only enters the RUN state if no faults are detected. Default setting: FALSE		
Submodule OK	BOOL	R	TRUE: No submodule fault, no channel faults. FALSE: Submodule fault, channel faults (external faults included).		
Submodule Status	DWORD	R	Bit-coded submodule status. For coding details, see Chapter 4.3.4.		

Table 22: The I/O Submodule DI 32_51 Tab in the Hardware Editor

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4.3.3 The I/O Submodule DI32_51: Channels Tab

The **I/O Submodule DI32_51: Channels** tab contains the following system parameters for each digital input.

Global variables can be assigned to the system parameters with -> and used in the user program. The value without -> must be directly entered.

System parameter	Data type	R/W	Description		
Channel no.		R	Channel number, preset and cannot be changed.		
-> Channel Value [BOOL]	BOOL	R	Boolean value of the digital input LOW or HIGH.		
-> Channel OK	BOOL	R	TRUE: Fault-free channel.		
[BOOL]			The channel value is valid.		
			FALSE: Faulty channel.		
			The input value is set to FALSE.		
T on [μs]	UDINT	W	Time on delay The module only indicates a level change from LOW to HIGH if the high level is present for longer than the configured time t_{on} .		
			The time on delay cannot be extended by more than the cycle time of the module. This also results in a delayed evaluation of the -> <i>Channel Value [BOOL]</i> parameter. Range of values: 0(2 ³¹ –1) Granularity: 1000 µs, e.g., 0, 1000, 2000, Default setting: 0		
T off [µs]	UDINT	W	Time off delay		
			The module only indicates a level change from HIGH to LOW if the low level is present for longer than the configured time toff.		
			The time off delay cannot be extended by more than the cycle time of the module. This also results in a delayed evaluation of the -> Channel Value [BOOL] parameter. Range of values: 0(2 ³¹ - 1) Granularity: 1000 µs, e.g., 0, 1000, 2000, Default setting: 0		
Test Suppression [µs]	UDINT	W	The digital input module can filter out external test impulses (set from HIGH to LOW for a short time) that last for the duration of t _{Pulse} < t _{Suppression} . The suppression time t _{Suppression} can be configured by the user. The highest suppression time configured for a channel applies to all channels on the module if the suppression time set for the channels is greater than 0. Note that the duration of the I/O cycle and thus that of the CPU cycle are extended. Range of values: 0500 µs Default setting: 0 (deactivated for this channel).		

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System parameter	Data type	R/W	Description
Redund.	BOOL	W	Requirement: The redundant module must exist. Activated: The channel redundancy for this channel is active. Deactivated: Deactivate the channel redundancy for this channel.
Redundancy Value	BYTE	W	Default setting: Deactivated Setting for determining the redundancy value. And Or Default setting: Or It is only displayed in the redundancy group tab!

Table 23: The I/O Submodule DI32_51: Channels Tab in the Hardware Editor

4.3.4 Description of Submodule Status [DWORD]

The following table specifies the coding of the *Submodule Status* parameter:

Coding	Description
0x00000001	Fault in hardware unit (submodule).
0x04000000	Internal error.
0x08000000	
0x10000000	
0x20000000	
0x40000000	
0x80000000	

Table 24: Coding of Submodule Status [DWORD]

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4.3.5 Description of *Diagnostic Status [DWORD]*

The following table specifies the coding of the *Diagnostic Status* parameter:

ID	Description				
0	Diagnostic values are indicated consecutively.				
100	Bit-coded temperature status.				
	0 = normal.				
		mperature threshold 1 has been exceeded.			
		perature threshold 2 has been exceeded.			
		ult in temperature measurement.			
101	Measured te	emperature (10 000 digits/ °C).			
200		oltage status.			
	0 = normal.				
		+ (24 V) is faulty.			
		+ (24 V) is faulty.			
201	Not used!				
202	_				
203					
300	Comparator 24 V undervoltage (BOOL).				
10011032	Status of the channels 132.				
	Coding	Description			
	0x0001	Fault occurred in hardware unit (submodule).			
	0x0002	Channel fault due to internal fault.			
	0x1000	Internal error			
	0x2000				
	0x4000	1			
	0x8000	1			
20012008	Fault status of the power sources 18 (supplies).				
	Coding	Description			
	0x8000	Internal error			

Table 25: Coding of Diagnostic Status [DWORD]

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4.4 Connection Variants

This chapter describes the technically proper wiring of the module. The following connection variants are permitted.

4.4.1 Input Wiring Variants

The inputs are wired via connector boards. Special connector boards are available for redundantly wiring the modules, see Chapter 3.6.

The supply is decoupled using diodes. This ensures that the supplies of two modules can supply one proximity switch if the modules are redundant to one another.

Connector boards X-CB 015 51 (with screw terminals) or X-CB 015 53 (with cable plug) can be used to perform the wiring such as described in Figure 12, Figure 13, Figure 14 and Figure 15.

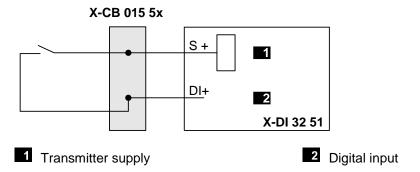


Figure 12: Wiring with Mechanical Contact or 2-Wire Proximity Switch

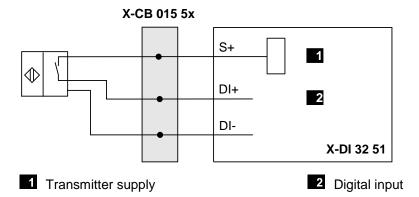
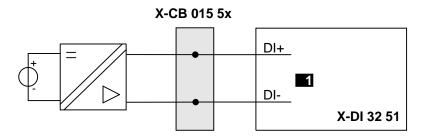


Figure 13: Wiring with 3-Wire Proximity Switch

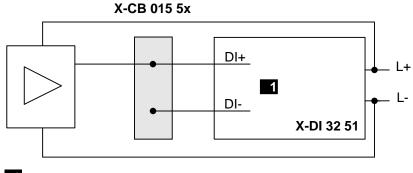
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1 Digital input

Figure 14: Wiring of a Digital Signal Source with Galvanically Separated Supply

When interconnecting a digital signal source with a non-galvanically separated supply to an input module, connect the signal source ground to the L- of the HIMax system.



1 Digital input

Figure 15: Wiring of a Digital Signal Source with Non-Galvanically Separated Supply

NOTICE



Overcurrent due to incorrect wiring!

Failure to comply with these instructions can damage the electronic components. Do not connect the ground of a digital signal source with a non-galvanically separated supply to the DI- of the input module.

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When redundantly wired as specified in Figure 16, Figure 17 and Figure 18, the input modules are inserted in the base plate next to each other and on a common connector board.

Connector boards X-CB 015 52 (with screw terminals) or X-CB 015 54 (with cable plug) can be used.

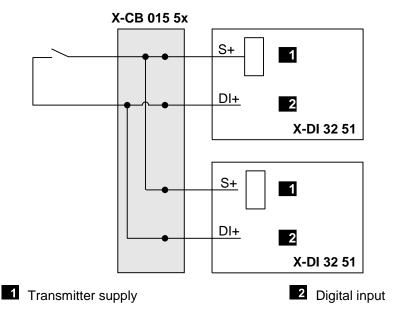


Figure 16: Redundant Wiring with Mechanical Contact or 2-Wire Proximity Switch

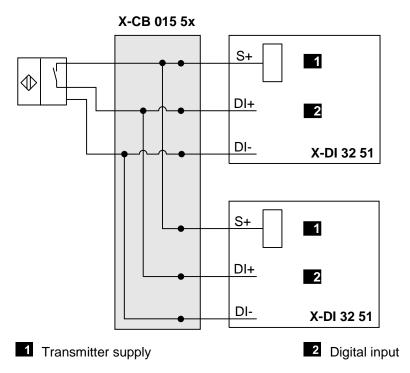
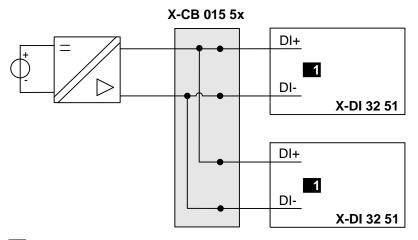


Figure 17: Redundant Wiring with 3-Wire Proximity Switch

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1 Digital input

Figure 18: Redundant Wiring of a Digital Signal Source with Galvanically Separated Supply

4.4.2 Connection to Transmitters via Field Termination Assembly

Mechanical contacts and transmitters are connected via the X-FTA 001 01 as described in Figure 19.

For further information, refer to the X-FTA 001 01 manual (HI 801 115 E).

The X-CB 015 53 connector board is used.

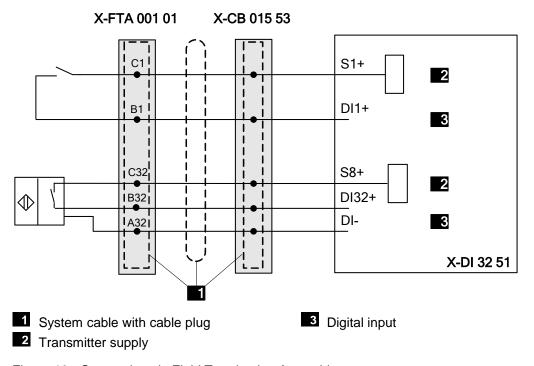


Figure 19: Connection via Field Termination Assembly

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X-DI 32 51 5 Operation

5 Operation

The module runs within a HIMax base plate and does not require any specific monitoring.

5.1 Handling

Direct handling of the module is not foreseen.

The module is operated from within the PADT, e.g., for forcing the digital inputs. For further details, refer to the SILworX documentation.

5.2 Diagnostics

LEDs on the front side of the module indicate the module state, see Chapter 3.4.2.

The diagnostic history of the module can also be read out using SILworX. Chapter 4.3.4 and Chapter 4.3.5 describe the most important diagnostic statuses.

 $\begin{tabular}{ll} i If a module is plugged in to a base plate, it generates diagnostic messages during its initialization phase indicating faults such as incorrect voltage values. \\ \end{tabular}$

These messages only indicate a module fault if they occur after the system starts operation.

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6 Maintenance X-DI 32 51

6 Maintenance

Defective modules must be replaced with a faultless module of the same type or with an approved replacement model.

When replacing modules, observe the instructions specified in the system manual (HI 801 001 E).

6.1 Maintenance Measures

As part of product maintenance, HIMA is continuously improving the operating systems of the modules. HIMA recommends using system downtimes to load the current operating system versions into the modules.

The current operating system versions of modules are displayed in the SILworX Control Panel. The type label specifies the delivered module version, see Chapter 3.3.

Before loading operating systems into the modules, check the system compatibilities and restrictions of the operating system versions. To this end, use the applicable release notes. Use SILworX to load the operating systems into the modules and ensure that these are in the STOP state.

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X-DI 32 51 7 Decommissioning

7 Decommissioning

To decommission the module, remove it from the base plate. For more details, refer to Chapter *Mounting and Removing the Module*.

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8 Transport X-DI 32 51

8 Transport

To avoid mechanical damage, the components must be transported in packaging.

Always store the components in their original product packaging. This packaging also provides protection against electrostatic discharge (ESD). Note that the product packaging alone is not sufficient for transport.

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X-DI 32 51 9 Disposal

9 Disposal

Industrial customers are responsible for correctly disposing of decommissioned hardware. Upon request, a disposal agreement can be arranged with HIMA.

All materials must be disposed of in an ecologically sound manner.





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X-DI 32 51 Appendix

Appendix

Glossary

Term	Description
Al	Analog input
AO	Analog output
ARP	Address resolution protocol, network protocol for assigning the network addresses to
	hardware addresses
COM	Communication module
CRC	Cyclic redundancy check
DI	Digital input
DO	Digital output
EMC	Electromagnetic compatibility
EN	European standard
ESD	Electrostatic discharge
FB	Fieldbus
FBD	Function block diagrams
HW	Hardware
ICMP	Internet control message protocol, network protocol for status or error messages
IEC	International electrotechnical commission
Interference-free	Inputs are designed for interference-free operation and can be used in circuits with safety functions
MAC	Media access control address, hardware address of one network connection
PADT	Programming and debugging tool (in accordance with IEC 61131-3), PC with SILworX
PELV	Protective extra low voltage
PES	Programmable electronic system
R	Read, the variable is read out
R/W	Read/Write, column title for system variable type
Rack ID	Base plate identification (number)
r P	Peak value of a total AC component
SB	System bus (module)
SC/OC	Short-circuit/open-circuit
SELV	Safety extra low voltage
SFF	Safe failure fraction, portion of faults that can be safely controlled
SIL	Safety integrity level (in accordance with IEC 61508)
SILworX	Programming tool
SNTP	Simple network time protocol (RFC 1769)
SRS	System.Rack.Slot, addressing of a module
SW	Software
TMO	Timeout
W	Write, the variable receives a value, e.g., from the user program
WD	Watchdog, device for monitoring the system's correct operation. Signal for fault-free process
WDT	Watchdog time

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MANUAL **X-DI 32 51**

HI 801 173 E

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